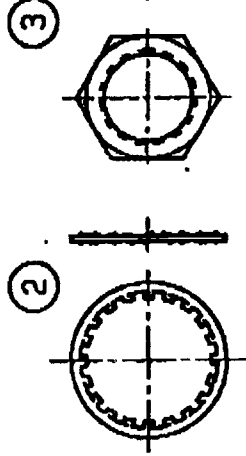


PCB HOLE CONFIGURATION



MOLEX RF P/N SYSTEM
SDA-73137-500*

- 1 CONTACT PLATING
- 3. GOLD (110 u")
- 5. TIN (200 u")

RECOMMENDED MOUNTING HOLE
MAXIMUM PANEL THICKNESS: 5.5 MM

3	1	NUT	BRASS	NICKEL PLATING	
2	1	LOCK WASHER	PHOSPHOR BRONZE	NICKEL PLATING	
1	1	BNC R/A PCB RECEPT.	BODY: ZINC ALLOY CONTACT: PHOSPHOR BRONZE INSULATOR: POLYPROPYLENE HOUSING: VALOX (BLACK)	NICKEL PLATING SEE P/N SYSTEM	
NO Q'TY	COMPONENT PART	MATERIAL	FINISH		
BY	DATE	MOLEX-ALIN, INC.			
DRAWN	DATE				
CHK'D	DATE				
APP'D	DATE				
MATERIAL:		SEE TABLE	TITLE		
FINISH:		SEE TABLE	GENERAL TOLERANCES		
DO NOT SCALE DRAWING		UNITS	MIN	SCALE	2:1
		ANGLE ±1'	DIM		10.26
		BNC R/A PCB RECEPTACLE (INCLUDED)			REV'D
		SDA-73137-500*			REV'D

- NOTES: 1. ALL COMPONENT PARTS SHOWN ON DRAWING ARE INCLUDED.
2. PRODUCT SPEC. #PS-73153-1000 APPLIES.
3. PACKING STYLE: TRAY PACK